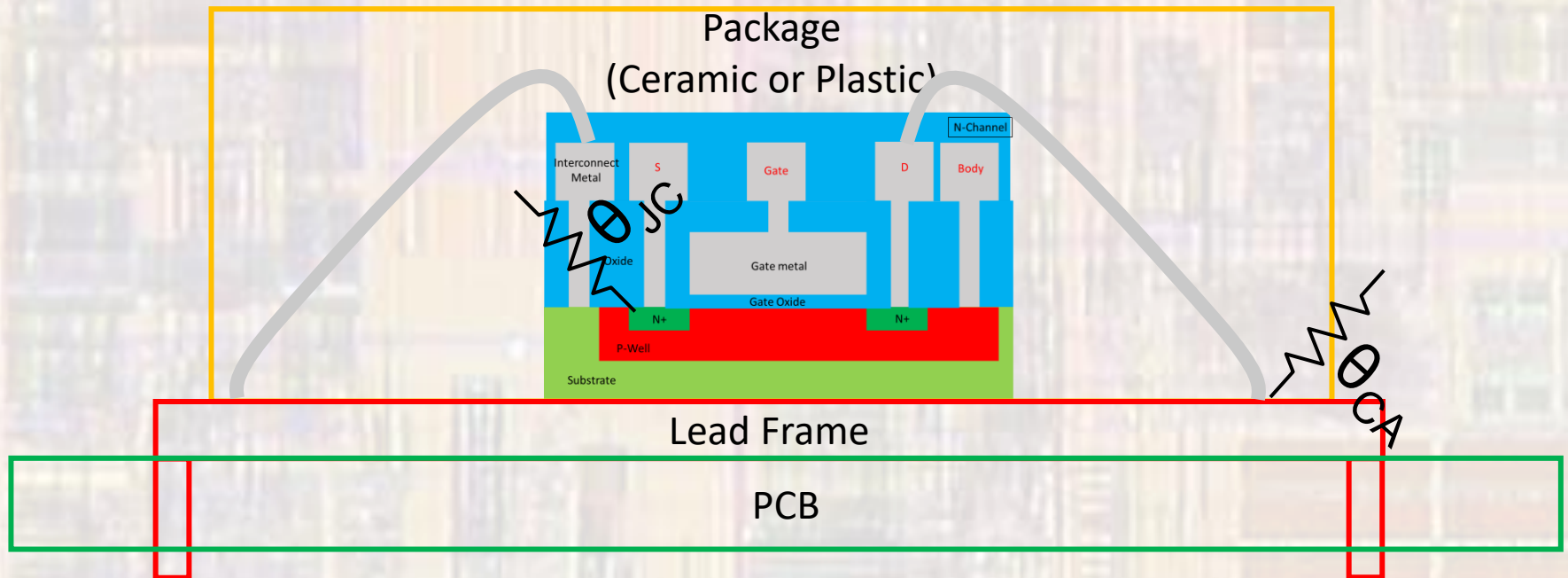


# Thermal Considerations

Last updated 1/10/24

# Thermal Considerations

- Semiconductor Thermal Constants
  - Semiconductor junctions start to fail at around 150°C
  - Two primary thermal paths
    - Junction to Case (package) -  $\theta_{JC}$ , Case to Ambient (outside) -  $\theta_{CA}$



# Thermal Considerations

- Semiconductor Thermal Constants

- $\theta_{JC}$  – thermal resistance from the junction to the case
- $\theta_{CA}$  – thermal resistance from the case to the ambient

- Since most users do not care about the intermediate temperature

- Often combined to be  $\theta_{JA}$

- e.g.  $\theta_{JC} = 60^{\circ}\text{C}/\text{W}$

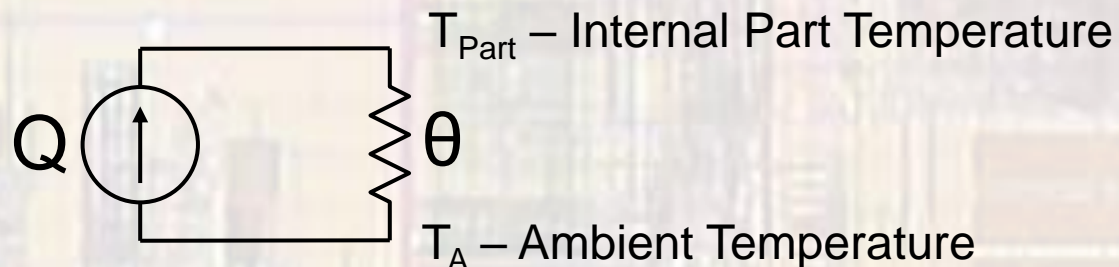
$$\theta_{CA} = 180^{\circ}\text{C}/\text{W}$$

$$\rightarrow \theta_{JA} = 240^{\circ}\text{C}/\text{W}$$

# Thermal Considerations

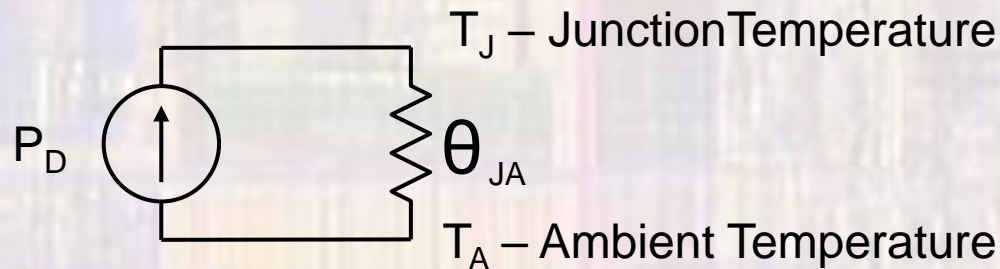
- Power Dissipation
  - Power dissipated in a part that is not provided to some load is converted into heat
- Electrical Analogy

Thermal	Electrical	Units
• Temp ( $\Delta T$ )	Voltage	( $^{\circ}\text{C}$ )
• Heat Flow ( $Q$ )	Current	(W)
• Thermal Resistance ( $\theta$ )	Electrical Resistance	( $^{\circ}\text{C}/\text{W}$ )
• Where $Q$ corresponds to electrical power wasted (turned to heat)		



# Thermal Considerations

- Power Dissipation



A part has a  $\theta_{JA} = 50^\circ\text{C}/\text{W}$

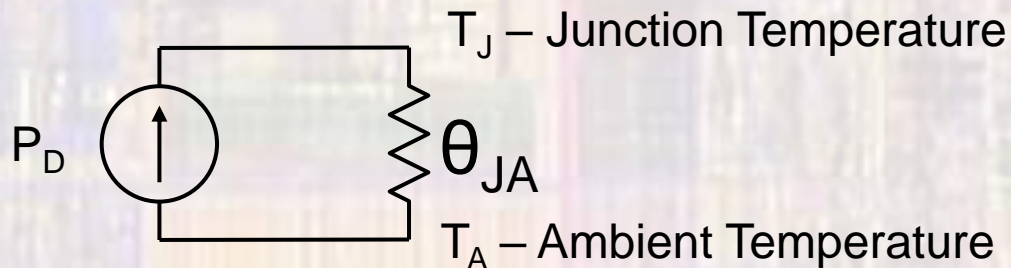
It dissipates 1W of wasted power  
The ambient temperature is  $27^\circ\text{C}$

Its junction temperature will be:

$$T_J = (P_d \times \theta_{JA}) + T_A = (1\text{W} \times 50^\circ\text{C}/\text{W}) + 27^\circ\text{C} = 77^\circ\text{C}$$

# Thermal Considerations

- Power Dissipation



A regulator has a  $\theta_{JA} = 240^\circ\text{C/W}$  and a  $T_{J\text{Max}} = 150^\circ\text{C}$

It dissipates 2W with 50% efficiency  $\rightarrow$  1W of wasted power  
The ambient temperature is  $27^\circ\text{C}$

Its junction temperature will be:

$$T_J = (P_D \times \theta_{JA}) + T_A = (1\text{W} \times 240^\circ\text{C/W}) + 27^\circ\text{C} = 267^\circ\text{C}$$

# Thermal Considerations

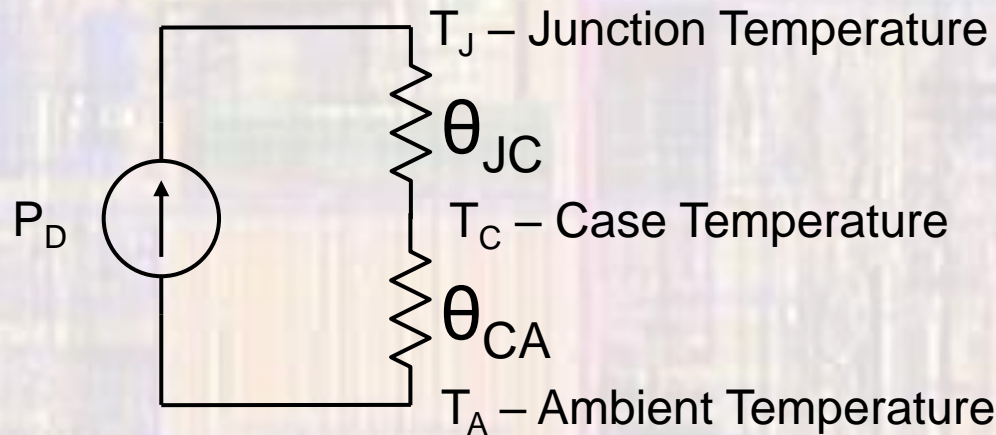
- Power Dissipation
  - We can't impact the  $\theta_{JC}$  but we can impact  $\theta_{CA}$ 
    - Attach a heat sink
- Heat Sink
  - By increasing the air–heat interface area, heat sinks allow more heat to be dissipated faster
  - Reduce the effective thermal resistance -  $\theta_{CA}$



$$\theta_{CA} = 15 \text{ }^{\circ}\text{C/W}$$

# Thermal Considerations

- Power Dissipation



A regulator has:  $\theta_{JA} = 240^\circ\text{C/W}$  ( $\theta_{JC} = 60^\circ\text{C/W}$ ,  $\theta_{CA} = 180^\circ\text{C/W}$ ) and  $T_{J\text{Max}} = 150^\circ\text{C}$   
A heat sink is attached with a new  $\theta_{CA} = 15^\circ\text{C/W}$

It dissipates 2W with 50% efficiency  $\rightarrow$  1W of wasted power  
The ambient temperature is  $27^\circ\text{C}$

Its junction temperature will be:

$$T_J = (P_D \times (\theta_{JC} + \theta_{CA})) + T_A = (1\text{W} \times (60^\circ\text{C/W} + 15^\circ\text{C/W}) + 27^\circ\text{C} = 102^\circ\text{C}$$